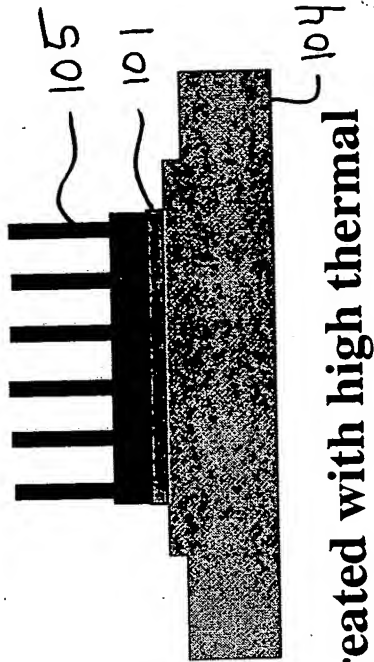


100 ↙

Figure 1B

Heat Sink



Thermal  
membrane  
film

Device to  
be cooled.

Hole treated with high thermal  
conductor

PDMS Membrane

FIGURE 1A

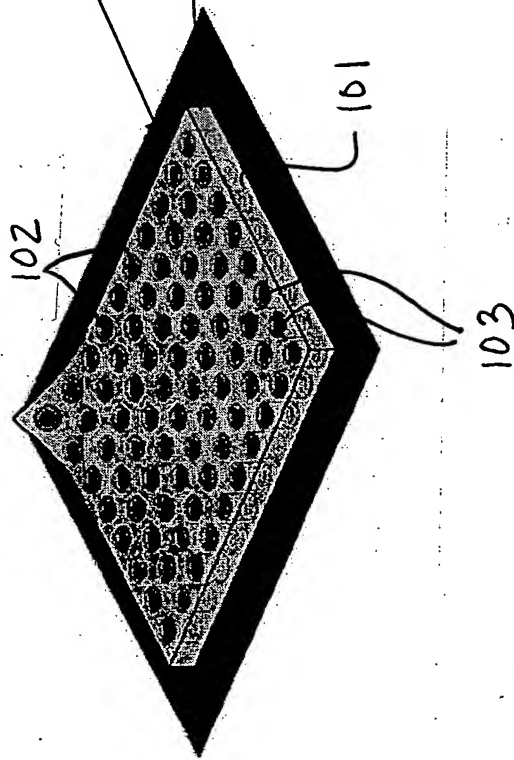
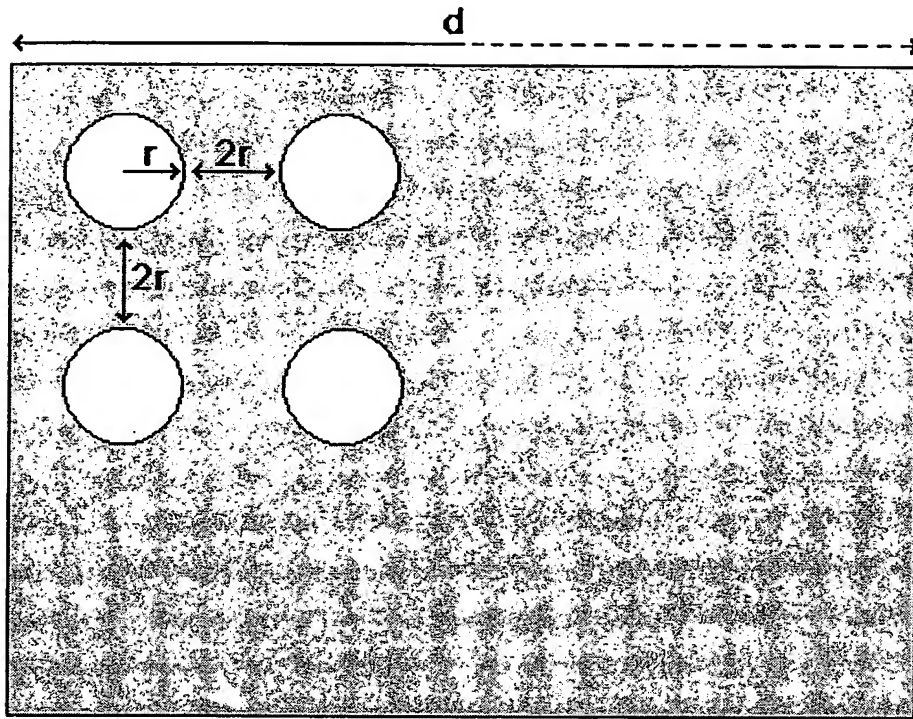


FIGURE 2A



200



FIGURE 2B

300 ↓

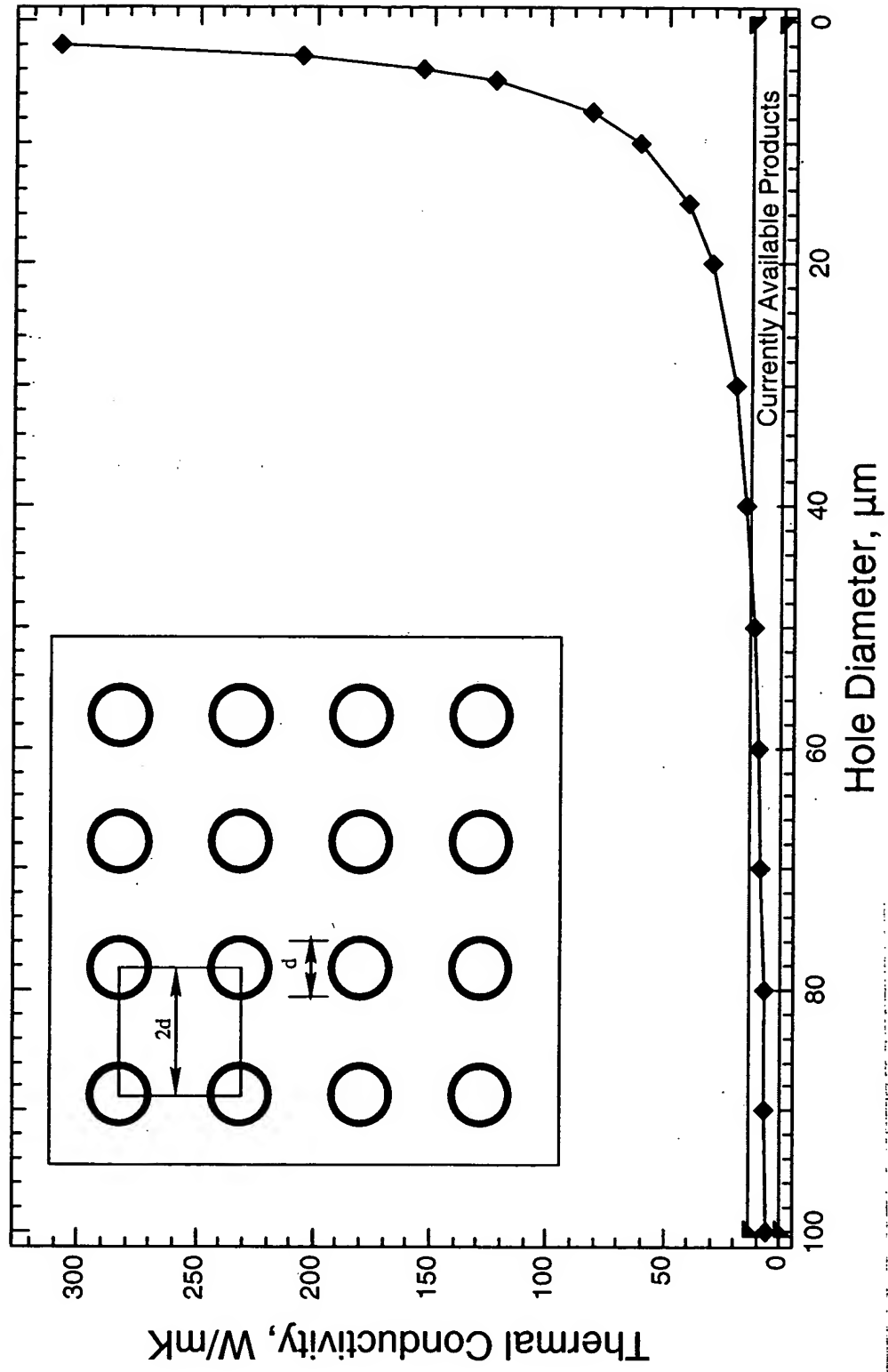
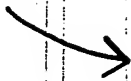
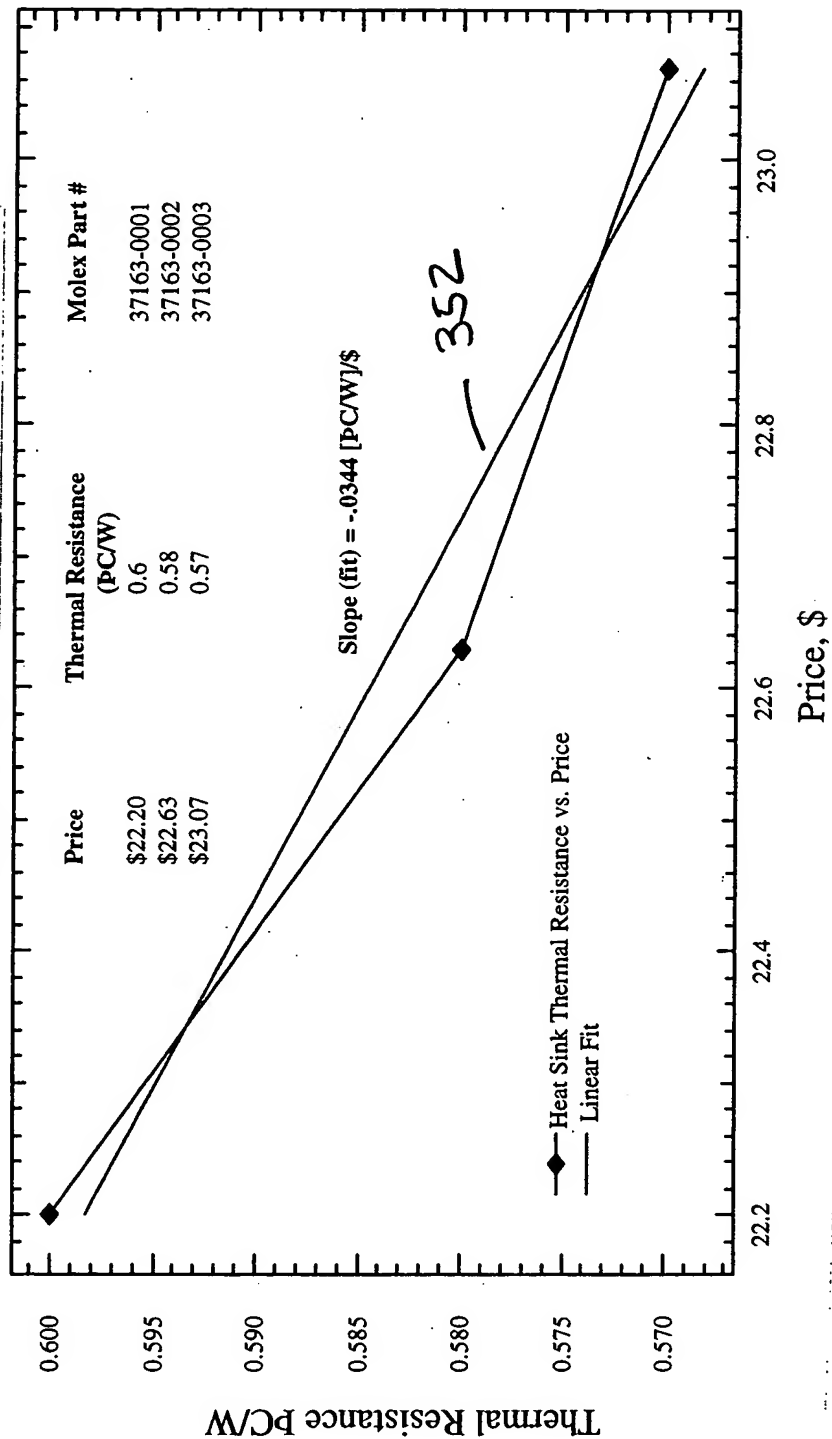


FIGURE 3

350



### Pentium IVR Heat Sinks



352

FIGURE 4

400  
↙

Hard Bake Cure Station

